# Numerical Engineering Analysis (MAE-5093) # Home Work - 6

S M Abdullah Al Mamun CWID: A20138451

November 29, 2018

# 1 Problem

The steady state temperature distribution u(x, y) in a rectangular copper plate satisfies Laplace's equation:

$$\frac{\partial^2 u}{\partial x^2} + \frac{\partial^2 u}{\partial y^2} = 0 \tag{1}$$

The upper and lower boundaries are perfectly insulated  $(\frac{\partial u}{\partial y} = 0)$ ; the left side is kept at  $0^{\circ}C$ , and the right side at  $f(y) = y^{\circ}C$ .

### 1.1 Part (a)

Results plotted for part(a):

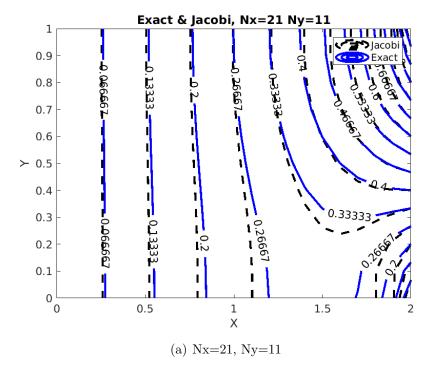


Figure 1: Temperature distribution using Jacobi method when the grid size is kept uniform.

## 1.2 Part (b)

#### Results plotted for part(b):

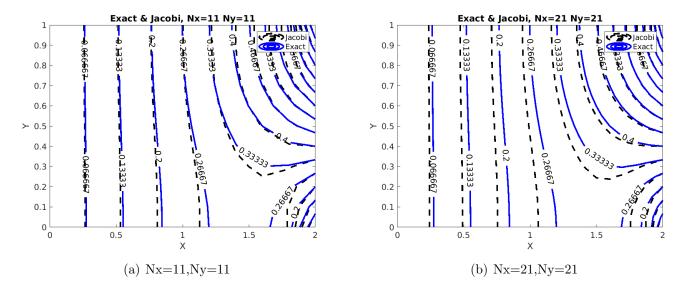


Figure 2: Temperature distribution using Jacobi method when the grid size is kept non-uniform.

## 1.3 Part (c)

#### Results plotted for part(c):

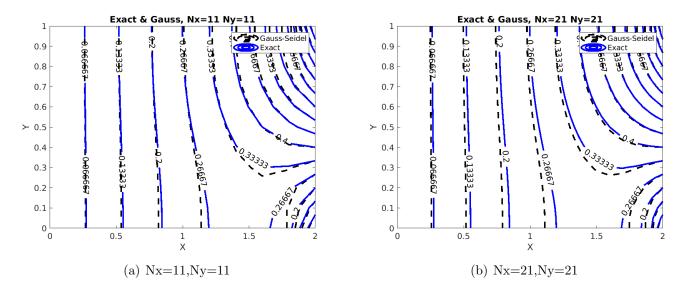


Figure 3: Temperature distribution using Gauss-Seidel method when the grid size is kept non-uniform.

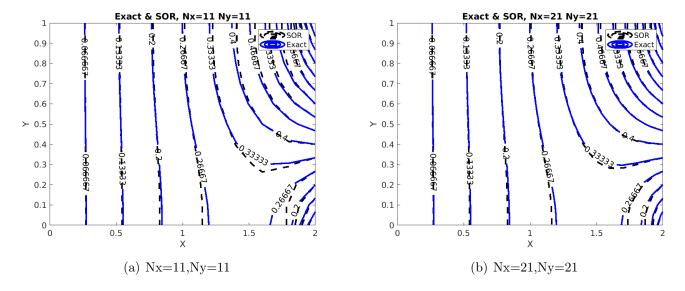


Figure 4: Temperature distribution using SOR method when the grid size is kept non-uniform.

### Conclusion:

Table 1: Results

Cases	Iteration required	Absolute error	Percentage error
Jacobi(Nx=21,Ny=11)	620	0.0072	2.86
Jacobi(Nx=11,Ny=11)	438	0.0042	1.66
Jacobi(Nx=21,Ny=21)	1163	0.0193	7.72
Gauss-Seidel(Nx=11,Ny=11)	276	0.0019	0.76
Gauss-Seidel(Nx=21,Ny=21)	747	0.0096	3.85
SOR(Nx=11,Ny=11)	71	0.00005	0.0219
SOR(Nx=21,Ny=21)	177	0.0007	0.30